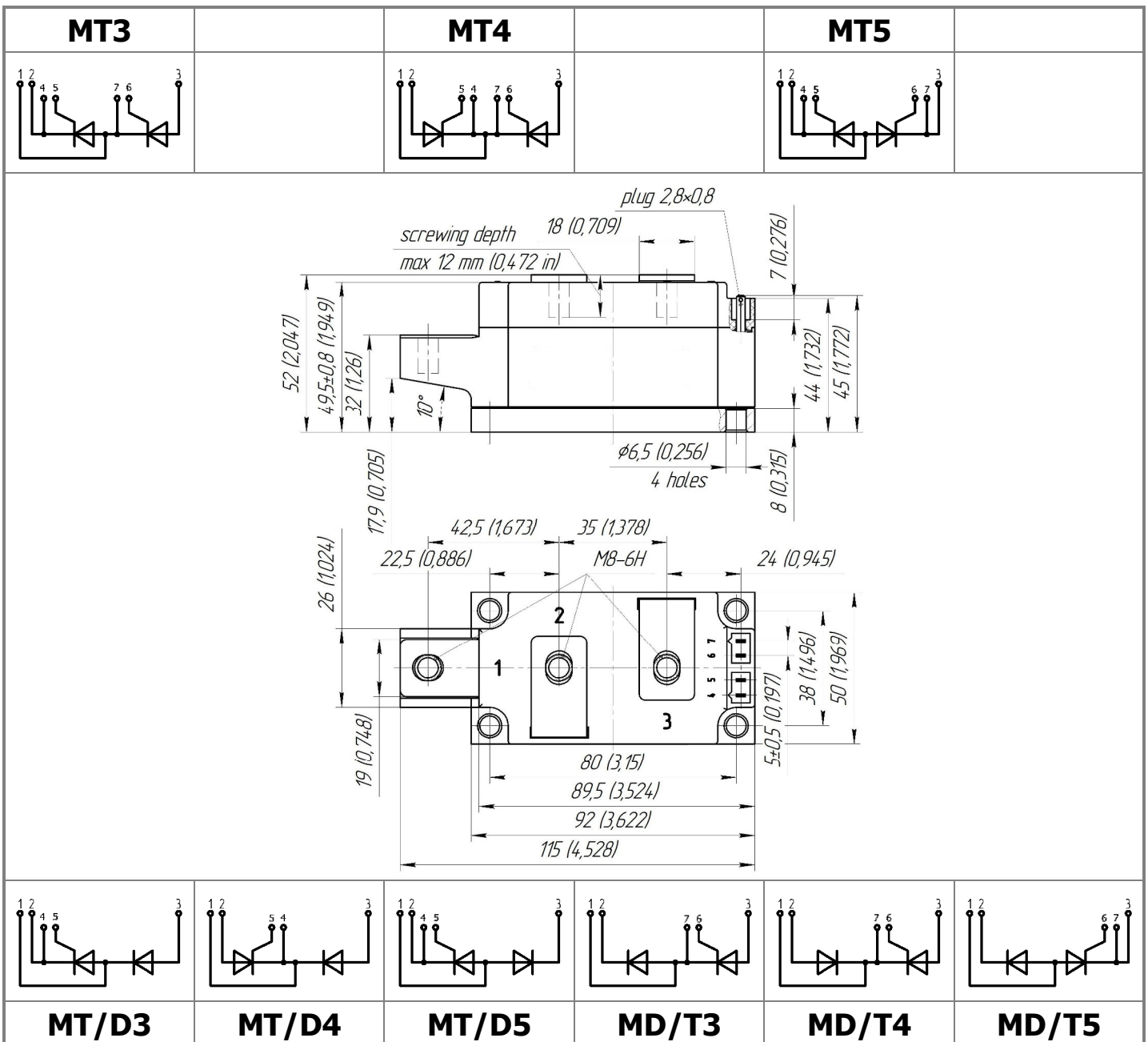




Electrically isolated base plate
Industrial standard package
Simplified mechanical design, rapid assembly
Pressure contact

**Double Thyristor Module
For Phase Control
MTx-160-36-C1**

Mean on-state current	I_{TAV}		160 A	
Repetitive peak off-state voltage	V_{DRM}		3000 ÷ 3600 V	
Repetitive peak reverse voltage	V_{RRM}			
Turn-off time	t_q		300 μ s	
V_{DRM}, V_{RRM}, V	3000	3200	3400	3600
Voltage code	30	32	34	36
$T_{ij}, ^\circ C$	- 40 ÷ 125			



All dimensions in millimeters (inches)

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
ON-STATE				
I_{TAV}	Mean on-state current	A	160 169	$T_c=88\text{ }^\circ\text{C}$; $T_c=85\text{ }^\circ\text{C}$; 180° half-sine wave; 50 Hz
I_{TRMS}	RMS on-state current	A	251	$T_c=88\text{ }^\circ\text{C}$; 180° half-sine wave; 50 Hz
I_{TSM}	Surge on-state current	kA	4.0 4.6	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; 50 Hz ($t_p=10\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
			5.0 5.8	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; 60 Hz ($t_p=8.3\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
I^2t	Safety factor	$A^2s\cdot 10^3$	80 105	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; 50 Hz ($t_p=10\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
			100 135	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; 60 Hz ($t_p=8.3\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
BLOCKING				
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	3000÷3600	$T_{j\text{ min}} < T_j < T_{j\text{ max}}$; 180° half-sine wave; 50 Hz; Gate open
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3100÷3700	$T_{j\text{ min}} < T_j < T_{j\text{ max}}$; 180° half-sine wave; 50 Hz; single pulse; Gate open
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.75\cdot V_{DRM}$ $0.75\cdot V_{RRM}$	$T_j=T_{j\text{ max}}$; Gate open
TRIGGERING				
I_{FGM}	Peak forward gate current	A	6	$T_j=T_{j\text{ max}}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	3	$T_j=T_{j\text{ max}}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1\text{ Hz}$)	$A/\mu\text{s}$	200	$T_j=T_{j\text{ max}}$; $V_D=0.67\cdot V_{DRM}$; $I_{TM}=2 I_{TAV}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
THERMAL				
T_{stg}	Storage temperature	$^\circ\text{C}$	-40 ÷ 50	
T_j	Operating junction temperature	$^\circ\text{C}$	-40 ÷ 125	
MECHANICAL				
a	Acceleration under vibration	m/s^2	50	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	2.50	$T_j=25\text{ °C}; I_{TM}=785\text{ A}$	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.20	$T_j=T_{j\text{ max}};$	
r_T	On-state slope resistance, max	mΩ	2.300	$0.5\pi I_{TAV} < I_T < 1.5\pi I_{TAV}$	
I_L	Latching current, max	mA	700	$T_j=25\text{ °C}; V_D=12\text{ V};$ Gate pulse: $I_G=2\text{ A};$ $t_{GP}=50\text{ μs}; di_G/dt \geq 1\text{ A/μs}$	
I_H	Holding current, max	mA	300	$T_j=25\text{ °C};$ $V_D=12\text{ V};$ Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	50	$T_j=T_{j\text{ max}};$ $V_D=V_{DRM}; V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage, min	V/μs	1000	$T_j=T_{j\text{ max}};$ $V_D=0.67V_{DRM};$ Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	3.50 2.00 1.50	$T_j=T_{j\text{ min}}$ $T_j=25\text{ °C}$ $T_j=T_{j\text{ max}}$	$V_D=12\text{ V}; I_D=3\text{ A};$ Direct gate current
I_{GT}	Gate trigger direct current, max	mA	250 150 100	$T_j=T_{j\text{ min}}$ $T_j=25\text{ °C}$ $T_j=T_{j\text{ max}}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.25	$T_j=T_{j\text{ max}};$ $V_D=0.67V_{DRM};$	
I_{GD}	Gate non-trigger direct current, min	mA	10.00	Direct gate current	
SWITCHING					
t_{gd}	Delay time	μs	3.00	$T_j=25\text{ °C}; V_D=0.4V_{DRM}; I_{TM}=I_{TAV};$ Gate pulse: $I_G=2\text{ A};$ $t_{GP}=50\text{ μs}; di_G/dt \geq 1\text{ A/μs}$	
t_q	Turn-off time, max	μs	300	$dv_D/dt=50\text{ V/μs}; T_j=T_{j\text{ max}}; I_{TM}=150\text{ A};$ $di_R/dt=-10\text{ A/μs}; V_R=100\text{ V};$ $V_D=0.67V_{DRM}$	
THERMAL					
R_{thjc}	Thermal resistance, junction to case			180° half-sine wave, 50 Hz	
	per module	°C/W	0.0550		
	per arm	°C/W	0.1100		
R_{thch}	Thermal resistance, case to heatsink				
	per module	°C/W	0.0200		
	per arm	°C/W	0.0400		
INSULATION					
V_{ISOL}	Insulation test voltage	kV	3.00	Sine wave, 50 Hz; RMS	t=1 min
			3.60		t=1 sec
MECHANICAL					
M_1	Mounting torque (M6) ¹⁾	Nm	6.00	Tolerance ± 15%	
M_2	Terminal connection torque (M8) ¹⁾	Nm	9.00	Tolerance ± 15%	
w	Weight	g	800		

PART NUMBERING GUIDE						NOTES				
MT	3	-	160	-	36	-	C1	-	N	
1	2		3		4		5		6	
1. Thyristor module (MT) Thyristor – Diode module (MT/D) Diode – Thyristor module (MD/T) 2. Circuit Schematic 3. Average On-state Current, A 4. Voltage Code 5. Package Type (M.C1) 6. Ambient Conditions: N – Normal										
										1) The screws must be lubricated

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